



**THE DATASHEET OF  
BC847BQBZ**





# BC56PA-Q series

80 V, 1 A NPN medium power transistors

Rev. 2 — 24 June 2022

Product data sheet

## 1. General description

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NPN medium power transistor in a SOT1061 (DFN2020-3) leadless very small Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

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- High collector current capability  $I_C$  and  $I_{CM}$
- Three current gain selections
- High power dissipation capability
- Exposed heatsink for excellent thermal and electrical conductivity
- Leadless very small SMD plastic package with medium power capability
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

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- Linear voltage regulators
- MOSFET drivers
- Low-side switches
- Power management
- Amplifiers
- Battery-driven devices

## 4. Quick reference data

**Table 1. Quick reference data**

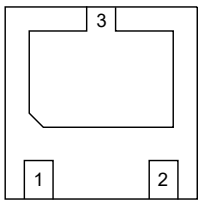
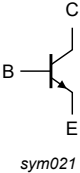
$T_{amb} = 25\text{ °C}$  unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{CE0}$	collector-emitter voltage	open base		-	-	80	V
$I_C$	collector current			-	-	1	A
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1\text{ ms}$		-	-	2	A
$h_{FE}$	DC current gain						
	BC56PA-Q	$V_{CE} = 2\text{ V}; I_C = 150\text{ mA}$	[1]	63	-	250	
	BC56-10PA-Q		[1]	63	-	160	
	BC56-16PA-Q		[1]	100	-	250	

[1] pulsed;  $t_p \leq 300\text{ }\mu\text{s}$ ;  $\delta \leq 0.02$

## 5. Pinning information

**Table 2. Pinning**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base	 <p>Transparent top view</p>	 <p>sym021</p>
2	E	emitter		
3	C	collector		

## 6. Ordering information

**Table 3. Ordering information**

Type number	Package		
	Name	Description	Version
BC56PA-Q	DFN2020-3	plastic, thermal enhanced ultra thin small outline package; no leads; 3 Terminals; body 2 x 2 x 0.65 mm	SOT1061
BC56-10PA-Q			
BC56-16PA-Q			

## 7. Marking

**Table 4. Marking**

Type number	Marking code
BC56PA-Q	AZ
BC56-10PA-Q	BK
BC56-16PA-Q	BL

## 8. Limiting values

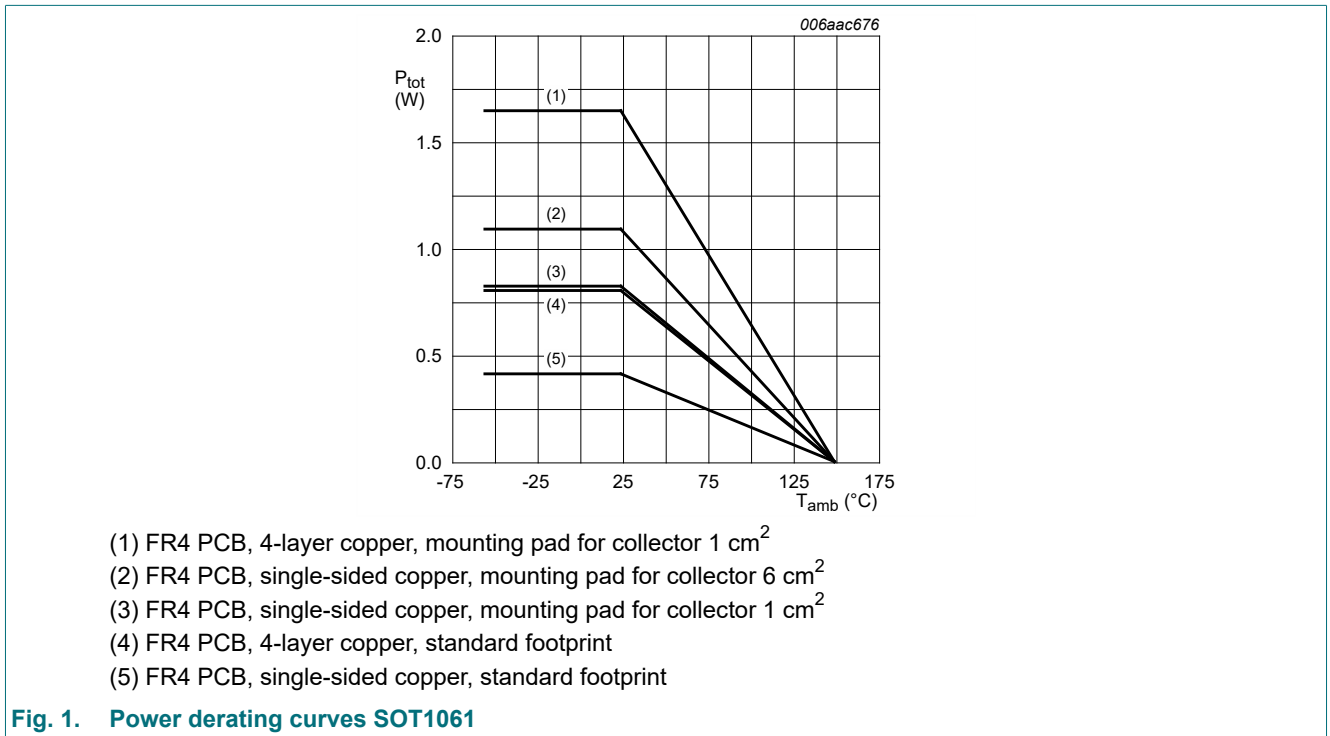
**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

$T_{amb} = 25\text{ °C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit	
$V_{CBO}$	collector-base voltage	open emitter	-	100	V	
$V_{CEO}$	collector-emitter voltage	open base	-	80	V	
$V_{EBO}$	emitter-base voltage	open collector	-	5	V	
$I_C$	collector current		-	1	A	
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	2	A	
$I_B$	base current		-	0.3	A	
$I_{BM}$	peak base current	single pulse; $t_p \leq 1\text{ ms}$	-	0.3	A	
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	-	0.42	W
			[2]	-	0.83	W
			[3]	-	1.10	W
			[4]	-	0.81	W
			[5]	-	1.65	W
$T_j$	junction temperature		-	150	°C	
$T_{amb}$	ambient temperature		-55	150	°C	
$T_{stg}$	storage temperature		-65	150	°C	

- [1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector  $1\text{ cm}^2$ .
- [3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector  $6\text{ cm}^2$ .
- [4] Device mounted on an FR4 PCB; 4-layer copper; tin-plated and standard footprint.
- [5] Device mounted on an FR4 PCB; 4-layer copper; tin-plated; mounting pad for collector  $1\text{ cm}^2$ .



**Fig. 1. Power derating curves SOT1061**

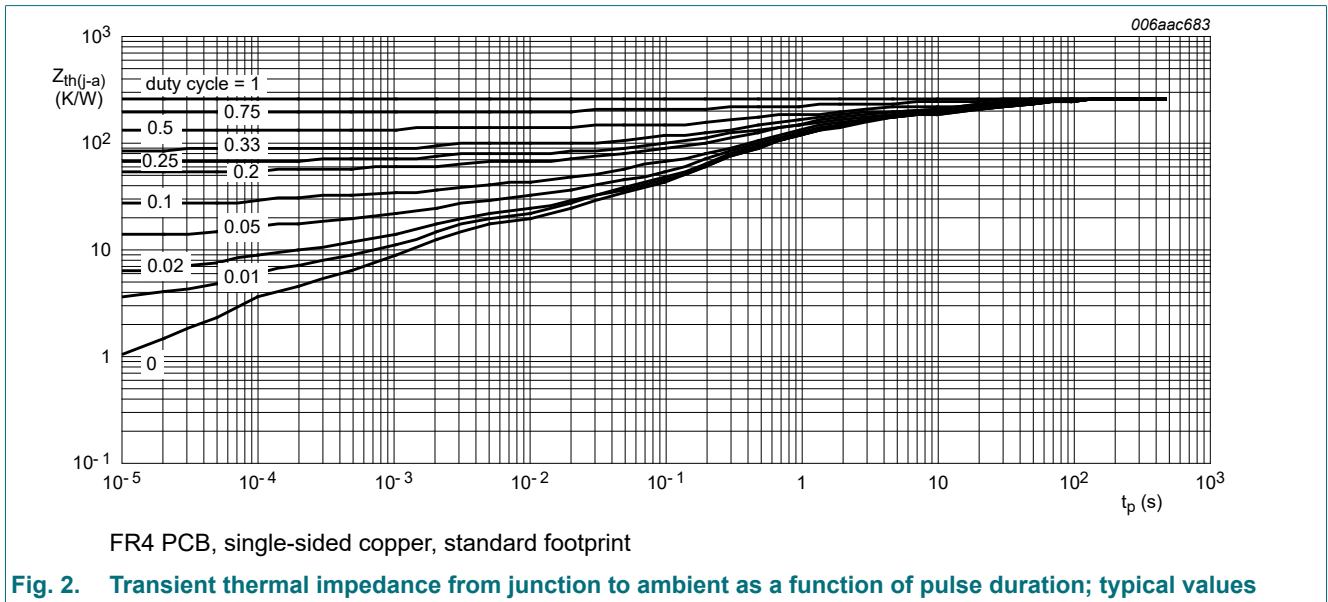
## 9. Thermal characteristics

**Table 6. Thermal characteristics**

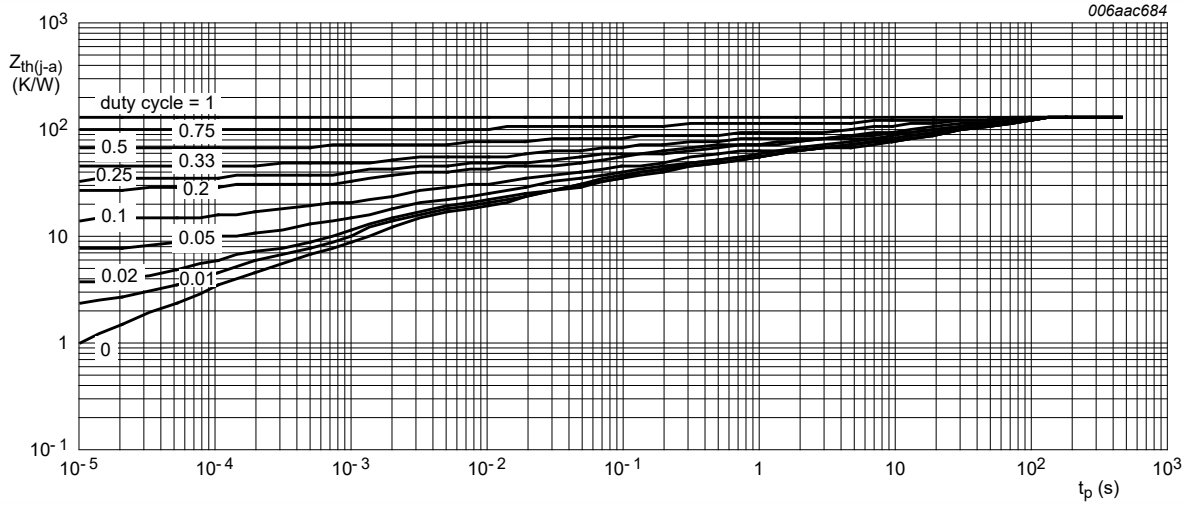
$T_{amb} = 25\text{ °C}$  unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	298	K/W
			[2]	-	-	151	K/W
			[3]	-	-	114	K/W
			[4]	-	-	154	K/W
			[5]	-	-	76	K/W
$R_{(j-sp)}$	thermal resistance from junction to solder point			-	-	20	K/W

- [1] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
- [3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
- [4] Device mounted on an FR4 PCB; 4-layer copper; tin-plated and standard footprint.
- [5] Device mounted on an FR4 PCB; 4-layer copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.

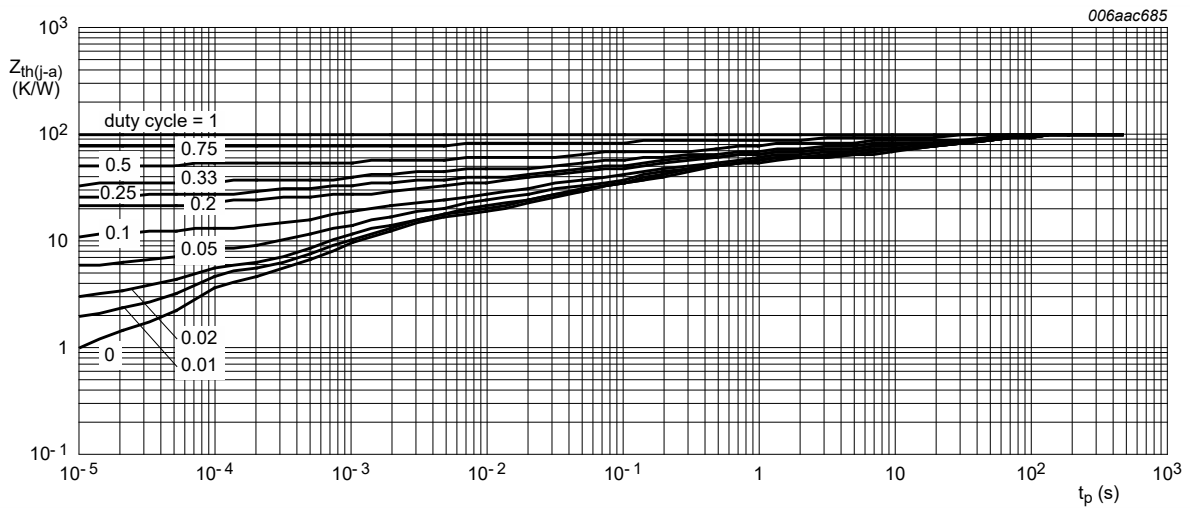


**Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**



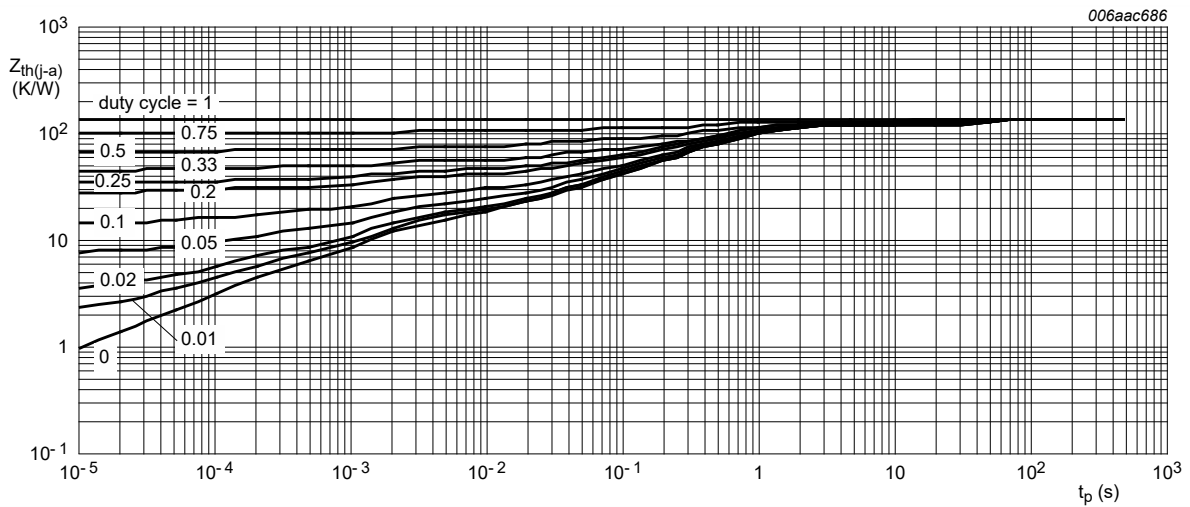
FR4 PCB, single-sided copper, mounting pad for collector 1 cm<sup>2</sup>

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



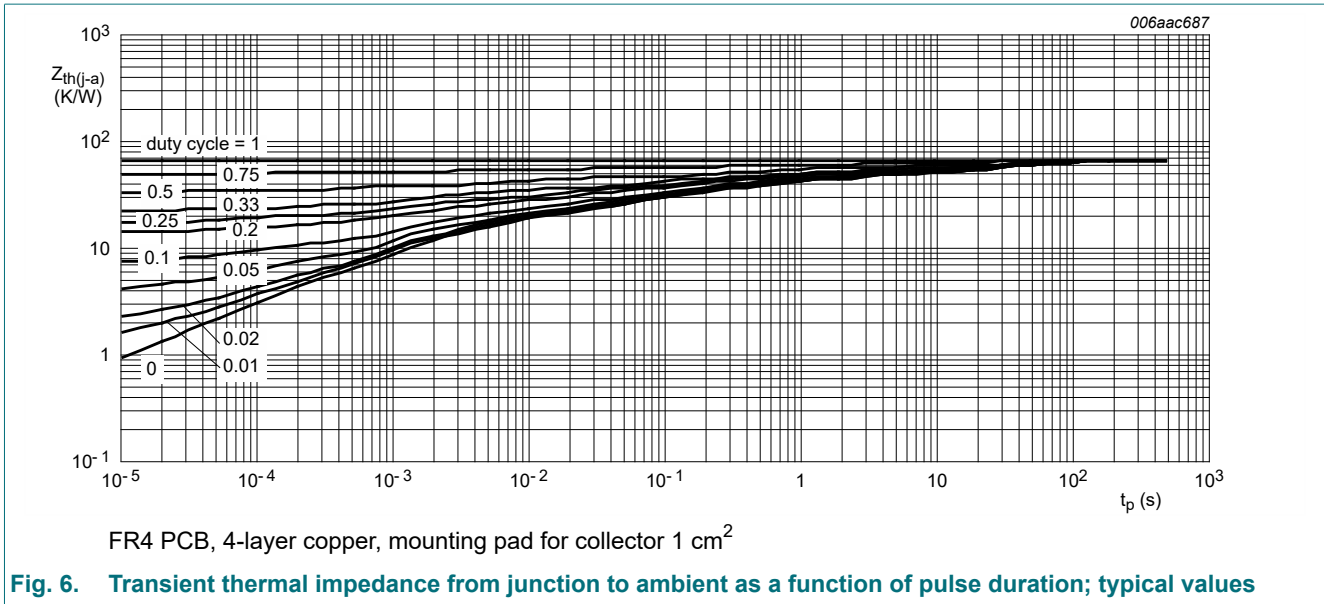
FR4 PCB, single-sided copper, mounting pad for collector 6 cm<sup>2</sup>

Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, 4-layer copper, standard footprint

Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

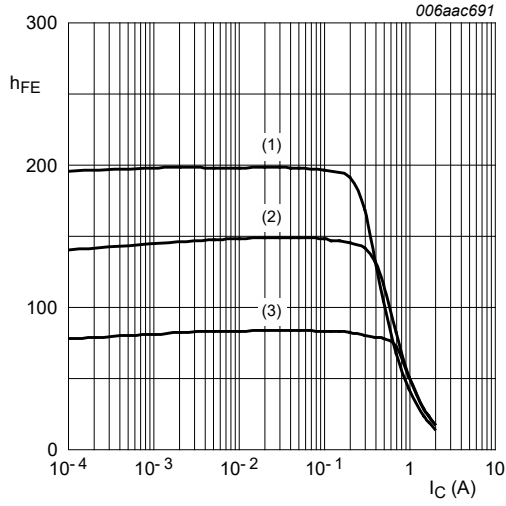


## 10. Characteristics

**Table 7. Characteristics**
 $T_{amb} = 25\text{ °C}$  unless otherwise specified.

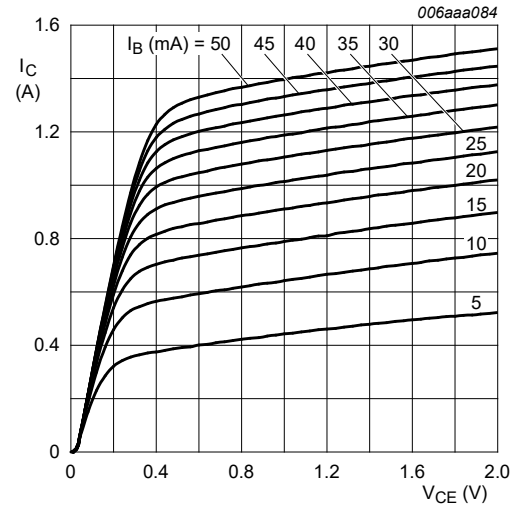
Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = 100\ \mu\text{A}; I_E = 0\ \text{A}$	100	-	-	V	
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = 2\ \text{mA}; I_B = 0\ \text{A}$	80	-	-	V	
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_E = 100\ \mu\text{A}; I_C = 0\ \text{A}$	5	-	-	V	
$I_{CBO}$	collector-base cut-off current	$V_{CB} = 30\ \text{V}; I_E = 0\ \text{A}$	-	-	100	nA	
		$V_{CB} = 30\ \text{V}; I_E = 0\ \text{A}; T_j = 150\text{ °C}$	-	-	10	$\mu\text{A}$	
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = 5\ \text{V}; I_C = 0\ \text{A}$	-	-	100	nA	
$h_{FE}$	DC current gain						
	BC56PA-Q	$V_{CE} = 2\ \text{V}; I_C = 5\ \text{mA}$	[1]	63	-	-	
		$V_{CE} = 2\ \text{V}; I_C = 150\ \text{mA}$	[1]	63	-	250	
		$V_{CE} = 2\ \text{V}; I_C = 500\ \text{mA}$	[1]	40	-	-	
	BC56-10PA-Q	$V_{CE} = 2\ \text{V}; I_C = 5\ \text{mA}$	[1]	63	-	-	
		$V_{CE} = 2\ \text{V}; I_C = 150\ \text{mA}$	[1]	63	-	160	
		$V_{CE} = 2\ \text{V}; I_C = 500\ \text{mA}$	[1]	40	-	-	
	BC56-16PA-Q	$V_{CE} = 2\ \text{V}; I_C = 5\ \text{mA}$	[1]	63	-	-	
		$V_{CE} = 2\ \text{V}; I_C = 150\ \text{mA}$		100	-	250	
$V_{CE} = 2\ \text{V}; I_C = 500\ \text{mA}$			40	-	-		
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = 500\ \text{mA}; I_B = 50\ \text{mA}$	[1]	-	500	mV	
$V_{BE}$	base-emitter voltage	$V_{CE} = 2\ \text{V}; I_C = 500\ \text{mA}$	[1]	-	1	V	
$C_C$	collector capacitance	$V_{CB} = 10\ \text{V}; I_E = i_e = 0\ \text{A}; f = 1\ \text{MHz}$	-	6	-	pF	
$f_T$	transition frequency	$V_{CE} = 5\ \text{V}; I_C = 50\ \text{mA}; f = 100\ \text{MHz}$	100	180	-	MHz	

[1] pulsed;  $t_p \leq 300\ \mu\text{s}$ ;  $\delta \leq 0.02$



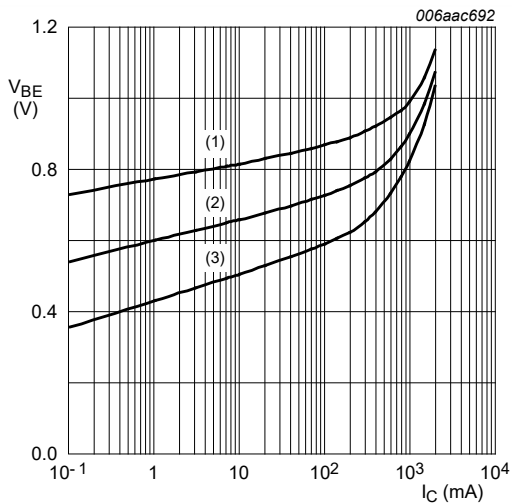
$V_{CE} = 2\text{ V}$   
 (1)  $T_{amb} = 100\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig. 7. DC current gain as a function of collector current; typical values**



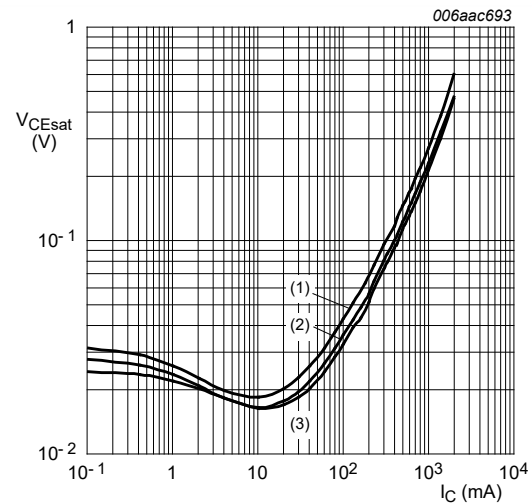
$T_{amb} = 25\text{ °C}$

**Fig. 8. Collector current as a function of collector-emitter voltage; typical values**



$V_{CE} = 2\text{ V}$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 100\text{ °C}$

**Fig. 9. Base-emitter voltage as a function of collector current; typical values**



$V_{CE} = 2\text{ V}$   
 (1)  $T_{amb} = 100\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig. 10. Collector-emitter saturation voltage as a function of collector current; typical values**

## 11. Test information

### 11.1. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline

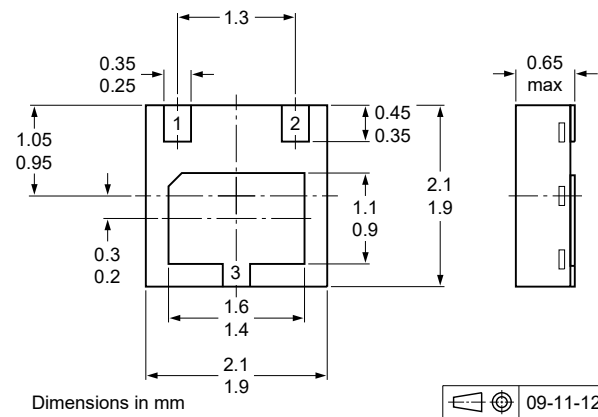


Fig. 11. Package outline SOT1061 (DFN2020-3)

13. Soldering

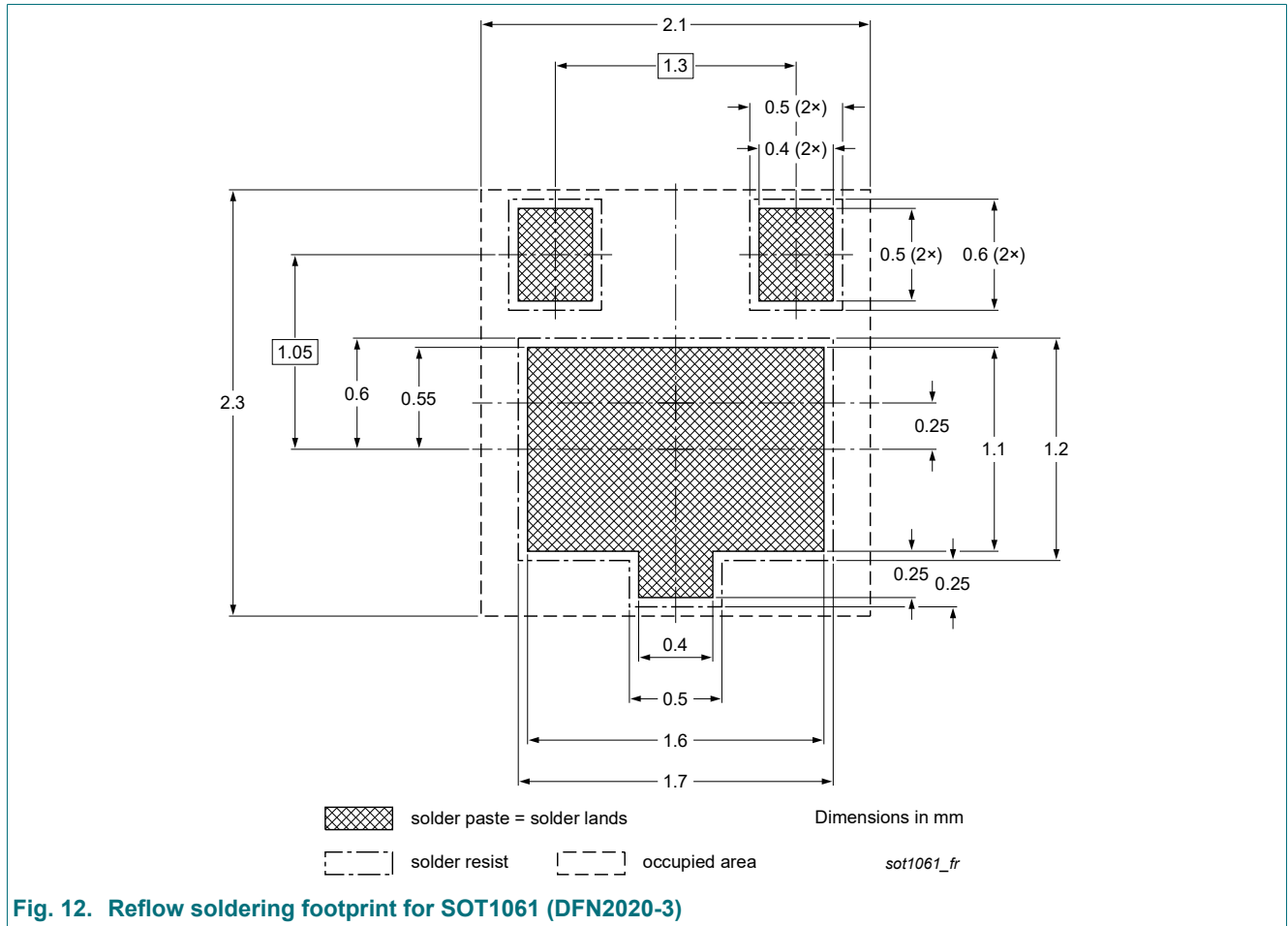


Fig. 12. Reflow soldering footprint for SOT1061 (DFN2020-3)

## 14. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BC56PA-Q_SER v.2	20220624	Product data sheet	-	BC56PA-Q_SER v.1
Modifications:	• Characteristics at $V_{(BR)CEO}$ : Conditions corrected			
BC56PA-Q_SER v.1	20220119	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 24 June 2022

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